## Features

- $0.4 \mathrm{~dB} @ 4 \mathrm{GHz}$ TX Insertion Loss
- $0.54 \mathrm{~dB} @ 4 \mathrm{GHz}$ RX Insertion Loss
- 41 dBm Input P0.1dB on TX Path
- 18 dB Typical Return Loss at Each RF Port
- Compatible with 1.8 V CMOS Logic
- 3 mm 16-Lead PQFN Package
- RoHS* Compliant


## Applications

- Wireless Infrastructure
- ISM
- Multi Market


## Description

The MASW-011191 is a single pole double throw (SPDT) switch with 0.4 dB of insertion loss in the TX path and 0.54 dB insertion loss in the RX path @ 4 GHz . The TX path is capable of handling 10 W input power. The input and output return losses in the thru path are typically 20 dB . The logic levels are standard 1.8 V CMOS. Only a single positive supply of +5 V is required.

The MASW-011191 is designed for transmit/receive applications between 500 MHz and 7.5 GHz . The 3 mm PQFN package is lead free and RoHS compliant. 5 dB of insertion loss in the TX path and 0.5 dB insertion loss in the RX path. The TX path is capable of handling 10 W input power. The input and output return losses in the thru path are typically 18 dB . The logic levels are standard 1.8 V CMOS. Only a single positive supply of +5 V is required.

The MASW-011191 is designed for transmit/receive applications between 500 MHz and 7.5 GHz . The 3 mm PQFN package is lead free and RoHS compliant.

## Ordering Information ${ }^{1}$

| Part Number | Package |
| :---: | :---: |
| MASW-011191-TR1000 | 1000 part Reel |
| MASW-011191-001SMB | Sample Board |

1. Reference Application Note M513 for reel size information.

## Functional Schematic



Pin Names ${ }^{2,3}$

| Pin \# | Function |
| :---: | :---: |
| $1,2,4,6,7,10,11,12,14,15$ | No Connection |
| 3 | TX Input/Output |
| 5 | ANT Common Port |
| 8 | VDD/+5 V |
| 9 | GND |
| 13 | Vcntrl Control Input |
| 16 | RX Input/Output |

2. MACOM recommends connecting unused package pins to ground.
3. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.
[^0]
## Pin Description

| Pin \# | Name | Description |
| :---: | :---: | :--- |
| 1 | NC | Not connected internally |
| 2 | NC | Not connected internally |
| 3 | TX | This pin is DC-decoupled and matched to 50ת. A DC-blocking capacitor is not be required on this pin |
| 4 | NC | Not connected internally |
| 5 | ANT | This pin is dc-decoupled and matched to 50』. A DC-blocking capacitor is not be required on this pin |
| 6 | NC | Not connected internally |
| 7 | NC | Not connected internally |
| 8 | VDD | Supply Voltage. Place bypass capacitor as close to pin as possible. |
| 9 | GND | This pin is grounded internally |
| 10 | NC | Not connected internally |
| 11 | NC | Not connected internally |
| 12 | NC | Not connected internally |
| 13 | Vcntrl | Switch Control Input |
| 14 | NC | Not connected internally |
| 15 | NC | Not connected internally |
| Paddle | GND | Exposed Pad. The exposed pad must be connected to a large RF/DC ground island providing thermal <br> capabilies for heat dissipation. |
| 16 | This pin is DC-coupled and matched to 50ת. A DC-blocking capacitor is required on this pin when DC |  |
| 15 |  |  |

Electrical Specifications: $P_{I N}=0 \mathrm{dBm}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{Z}_{\mathbf{0}}=50 \Omega$

| Parameter | Test Conditions | Units | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Insertion Loss, ANT to TX | 1.0 GHz 2.5 GHz 5.0 GHz 6.0 GHz | dB | - | $\begin{aligned} & 0.32 \\ & 0.34 \\ & 0.45 \\ & 0.50 \end{aligned}$ | $\begin{aligned} & \overline{0.9} \\ & 1.0 \\ & 1.2 \end{aligned}$ |
| Insertion Loss, ANT to RX | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | - | $\begin{aligned} & \hline 0.65 \\ & 0.50 \\ & 0.63 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & \overline{1.0} \\ & 1.2 \\ & 1.3 \end{aligned}$ |
| Isolation, ANT to RX in TX Mode | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | $\begin{aligned} & \overline{30} \\ & 26 \\ & 25 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 39.5 \\ & 36.0 \\ & 31.0 \\ & 29.5 \end{aligned}$ | - |
| Isolation, TX to RX in TX Mode | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | - | $\begin{aligned} & \hline 39.0 \\ & 34.0 \\ & 29.0 \\ & 27.5 \end{aligned}$ | - |
| Isolation, ANT to TX in RX Mode | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | $\begin{aligned} & \overline{23} \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & 36.0 \\ & 28.0 \\ & 19.0 \\ & 17.0 \end{aligned}$ | - |
| Isolation, TX to RX in RX Mode | $\begin{aligned} & 1.0 \mathrm{GHz} \\ & 2.5 \mathrm{GHz} \\ & 5.0 \mathrm{GHz} \\ & \text { 6.0 GHz } \end{aligned}$ | dB | - | $\begin{aligned} & 39.0 \\ & 32.5 \\ & 23.0 \\ & 20.0 \end{aligned}$ | - |
| ANT Port Return Loss in TX Mode | 1.0 GHz 2.5 GHz 5.0 GHz 6.0 GHz | dB | - | $\begin{aligned} & 22.0 \\ & 23.0 \\ & 23.0 \\ & 24.0 \end{aligned}$ | - |
| ANT Port Return Loss in RX Mode | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | - | $\begin{aligned} & 13.0 \\ & 20.0 \\ & 21.0 \\ & 21.0 \end{aligned}$ | - |
| TX Port Return Loss in TX Mode | 1.0 GHz <br> 2.5 GHz <br> 5.0 GHz <br> 6.0 GHz | dB | - | $\begin{aligned} & 20.0 \\ & 23.0 \\ & 24.0 \\ & 23.5 \end{aligned}$ | - |
| RX Port Return Loss in RX Mode | 1.0 GHz 2.5 GHz 5.0 GHz 6.0 GHz | dB | - | $\begin{aligned} & 11.5 \\ & 20.0 \\ & 22.5 \\ & 21.5 \end{aligned}$ | - |
| TX Input P0.1dB | $1-5 \mathrm{GHz}$ | dBm | - | 41 | - |
| RX Input P0.1dB | $1-5 \mathrm{GHz}$ | dBm | - | 30.5 | - |
| TX Input IP3 | +34 dBm per tone, 10 MHz spacing 2.5 GHz | dBm | - | 67.5 | - |
| RX Input IP3 | +34 dBm per tone, 10 MHz spacing 2.5 GHz | dBm | - | 67.0 | - |

## DC Electrical Specifications: $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$

| Parameter | Test Conditions | Units | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Switching Speed, TX Mode <br> Ton <br> Toff <br> TRISE <br> $\mathrm{T}_{\text {FALL }}$ | 50\% control to 90\% Voltage $50 \%$ control to $10 \%$ Voltage 10\% to $90 \%$ Voltage $90 \%$ to $10 \%$ Voltage | ns | - | $\begin{gathered} 410 \\ 135 \\ 140 \\ 45 \\ \hline \end{gathered}$ | - |
| Switching Speed, RX Mode $\mathrm{T}_{\text {ON }}$ $\mathrm{T}_{\text {OFF }}$ $\mathrm{T}_{\text {RISE }}$ $\mathrm{T}_{\text {FALL }}$ | 50\% control to 90\% Voltage $50 \%$ control to $10 \%$ Voltage $10 \%$ to $90 \%$ Voltage 90\% to 10\% Voltage | ns | - | $\begin{aligned} & 190 \\ & 80 \\ & 40 \\ & 26 \\ & \hline \end{aligned}$ | - |
| Supply Voltage, VDD | - | V | +4.75 | +5.0 | +5.25 |
| VDD Quiescent Current | TX Mode RX Mode | mA | - | $\begin{aligned} & 1.4 \\ & 1.0 \end{aligned}$ | - |
| Vcntrl Control Voltage | Logic High, $\mathrm{V}_{\mathrm{IH}}$ Logic Low, $\mathrm{V}_{\text {IL }}$ | V | - | $\begin{gathered} +1.8 \\ 0 \end{gathered}$ | - |
| T/R Logic Input Current | Logic High, $\mathrm{V}_{\mathrm{IH}}$ Logic Low, $\mathrm{V}_{\text {IL }}$ | $\mu \mathrm{A}$ | - | $\begin{gathered} \hline 40 \\ 0.04 \end{gathered}$ | - |

## Truth Table

| Control Input | T/R Path |  |
| :---: | :---: | :---: |
| VcntrI | RX | TX |
| $\mathrm{V}_{\mathrm{IH}}$ | On | Off |
| $\mathrm{V}_{\mathrm{IL}}$ | Off | On |

## Recommended Operating Conditions

| Parameter | Maximum |
| :---: | :---: |
| Input Power, TX Path | 37 dBm LTE |
|  | $(7 \mathrm{~dB}$ PAR) |
|  | 40 dBm CW |
| Input Power, RX Path | 26 dBm LTE |
|  | $(7 \mathrm{~dB} \mathrm{PAR})$ |
|  | 29 dBm CW |
| DC Supply VDD | 4.75 V to 5.25 V |
| Junction Temperature $^{4}$ | $125^{\circ} \mathrm{C}$ |
| Operating Temperature $^{5,6}$ | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |

4. Junction Temperature $\left(T_{J}\right)=T_{C}+\Theta j c *\left(V{ }^{*} I\right)$, Typical thermal resistance Өjc $=9.8^{\circ} \mathrm{C} / \mathrm{W}$.
5. Operating at nominal conditions with $\mathrm{T}_{J} \leq+125^{\circ} \mathrm{C}$ will ensure MTTF >> $1 \times 10^{6}$ hours
6. Operating/Case temperature $\left(T_{C}\right)$ is the temperature of the exposed paddle.

## Handling Procedures

Please observe the following precautions to avoid damage:

## Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1C, CDM Class C3 devices.

Absolute Maximum Ratings ${ }^{7,8,9}$

| Parameter | Absolute Maximum |
| :---: | :---: |
| Antenna Input Power | 39 dBm LTE |
| Freq. $=3.75 \mathrm{GHz}$ : TX Mode | $(8 \mathrm{~dB}$ PAR) |
| Antenna Input Power | 22 dBm CW |
| Freq. $=3.75 \mathrm{dHz}$ LTE RX Mode | $(8 \mathrm{~dB}$ PAR) |
| DC Supply VDD | 31 dBm CW |
| Control Voltage | -0.5 V to 5.5 V |
| Junction Temperature ${ }^{4}$ | -0.5 V to 2.75 V |
| Storage Temperature | $140^{\circ} \mathrm{C}$ |

7. Exceeding any one or combination of these limits may cause permanent damage to this device.
8. MACOM does not recommend sustained operation near these survivability limits.
9. Single event, up to 10 seconds duration.

## PCB Layout



## Parts List

| Part | Value | Case Style |
| :---: | :---: | :---: |
| C1 | 10 pF | 0402 |
| C2 | 1000 pF | 0402 |
| C3 | $1 \mu \mathrm{~F}$ | 0402 |
| C4 | 6.2 pF | 0402 |
| C5 | DNP | 0402 |
| C6 | 5 pF | 0402 |
| R1,R2 | $0 \Omega$ | 0402 |
| J1 - J5 | $142-0761-841$ | SMA, End Launch |

## Application Schematic



## Typical Performance Curves

Insertion Loss, ANT to TX


Isolation, ANT to RX in TX Mode


Isolation, TX to RX in TX Mode


Insertion Loss, ANT to RX


Isolation, ANT to TX in RX Mode


Isolation, RX to $T X$ in RX Mode


## Typical Performance Curves

## ANT Return Loss in TX Mode



TX Return Loss


ANT Return Loss in RX Mode


RX Return Loss


## Lead-Free 3 mm 16-Lead PQFN ${ }^{\dagger}$



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[^0]:    * Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

[^1]:    ${ }^{\dagger}$ Reference Application Note S2083 for lead-free solder reflow recommendations.
    Meets JEDEC moisture sensitivity level 1 requirements in accordance to JEDEC J-STD-020D.
    Plating is NiPdAu over Copper

